2S Modules for the Phase-2 Upgrade of the CMS Tracker

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The CMS experiment at the Large Hadron Collider LHC will face a new era after Long Shutdown 3, which is scheduled to take place between 2024 and 2026. The challenge of running a tracking detector at the High Luminosity LHC will be the high instantaneous luminosity of $5 \times 10^{34}$ s$^{-1}$cm$^{-2}$, leading to a total integrated luminosity of 3000 fb$^{-1}$. Due to the high instantaneous luminosity a particle flux of up to $1 \times 10^{15}$ n$_{eq}$cm$^{-2}$ is expected in the outer tracker region.

To cope with this challenge the existing CMS Outer Tracker has to be replaced by a completely new subdetector system. This Phase-2 tracker will have an increased granularity with $\leq 1\%$ occupancy in all regions and less material compared to the current detector. In addition the CMS Phase-2 tracker will contribute to the level-1 trigger with specialized detector modules with on-board transverse momentum discrimination. The Phase-2 Outer Tracker will consist of 5616 PS modules with a macro-pixel and a strip sensor on top of each other, and 7680 2S modules with two strip sensors on top of each other. In the next years standardized production lines for precise module building and testing are going to be installed in all 2S module production centers in the USA, Germany, Belgium, Pakistan, and India. The current plan foresees to integrate PS and 2S modules on tracker substructures starting 2022 and to start integrating the complete Phase-2 tracker in CMS in 2024 for the operation at the High Luminosity LHC.

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1. 2S Modules

The 2S modules (Figure 1) are built from two silicon strip sensors with a distance of 1.8 mm or 4 mm, depending on the region in the detector. Each sensor contains $2 \times 10^{16}$ strips with a length of 5 cm and a pitch of 90 $\mu$m. The active area of approximately 92 cm$^2$ on the $10 \times 10$ cm$^2$ sensor is read out by sixteen CBC3 front-end chips forming hit pairs from the two sensors. Power distribution, controls, and data readout are realized via service hybrids at the side of the module. The power consumption is 5.0 W for the front-end electronics and 1.0 W for the sensors at -20°C.

![Figure 1: 2S module [1]. Left: view of the assembled modules. Center: details of the module parts. Right: cross section of the module and front-end hybrid folded assembly and connectivity.](image)

2. Level-1 Trigger with Tracker Information

On the PS and 2S modules the CBC3 front-end chips correlate the signals from the two sensor planes and select pairs that form so-called stubs compatible with a particle above an adjustable transverse momentum threshold. These stubs are used to form tracks and the CMS Track Finder sends the track parameters with 40 MHz to the level-1 trigger, where the information is combined with the calorimeter and muon triggers. With up to 750 kHz the information is passed from the level-1 trigger to the CMS high-level trigger for further data reduction and final readout.

3. 2S Module Production Line

In a production center for CMS 2S modules several steps are necessary for module building and testing prior to module integration on larger tracker substructures. After reception tests of all parts, gluing steps are done to connect high voltage Kapton strips to the silicon sensors. The bare 2S module is built on a mechanical precision jig out of sensors, aluminium/carbon fiber reinforced distance bridges, front-end hybrids, and service hybrids. The mechanical assembly precision of the sensors must be better than 50 $\mu$m perpendicular to the strips and 100 $\mu$m parallel to the strips, with a tilt angle below 400 $\mu$rad. The precision is checked using a metrology machine. Wire bonding and wire bond encapsulation finalizes the 2S modules before a module burn-in test qualifies the modules for the integration on larger substructures. The first functional modules with non-final components have been built in 2018 within mechanical specifications.

References